BFR94A

NPN 5 GHz wideband transistor

Rev. 4 — 2 October 2014

Product data sheet

1. Product profile

1.1 General description

NPN wideband transistor in a plastic SOT23 package. PNP complement; BFT92

1.2 Features and benefits

- High power gain
- Low noise figure
- Low intermodulation distortion
- AEC-Q101 qualified

1.3 Applications

■ RF wideband amplifiers and oscillators

1.4 Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{CBO}	collector-base voltage		-	-	20	V
V_{CEO}	collector-emitter voltage		-	-	15	V
I _C	collector current		-	-	25	mA
P _{tot}	total power dissipation	T _{sp} ≤ 95 °C	-	-	300	mW
C _{re}	feedback capacitance	$I_C = I_C = 0 \text{ mA}; V_{CE} = 10 \text{ V};$ f = 1 MHz	-	0.35	-	pF
f _T	transition frequency	I _C = 15 mA; V _{CE} = 10 V; f = 500 MHz	-	5	-	GHz
G _{UM}	unilateral power gain	$I_{C} = 15 \text{ mA}; V_{CE} = 10 \text{ V};$ $T_{amb} = 25 ^{\circ}\text{C}$				
		f = 1 GHz	-	14	-	dB
		f = 2 GHz	-	8	-	dB
NF	noise figure	I_C = 5 mA; V_{CE} = 10 V; f = 1 GHz; Γ_S = Γ_{opt} ; T_{amb} = 25 °C	-	2.1	-	dB
V _O	output voltage	$\begin{split} & \text{IMD} = -60 \text{ dB; I}_{\text{C}} = 14 \text{ mA;} \\ & \text{V}_{\text{CE}} = 10 \text{ V; R}_{\text{L}} = 75 \Omega; \\ & \text{f}_{\text{p}} + \text{f}_{\text{q}} - \text{f}_{\text{r}} = 793.25 \text{ MHz} \end{split}$	-	150	-	mV



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2. Pinning information

Table 2. Pinning

Pin	Description	Simplified outline	Graphic symbol
1	base		_
2	emitter		3
3	collector	1 2	1 — 2 sym021

3. Ordering information

Table 3. Ordering information

Type number Package			
	Name	Description	Version
BFR94A	-	plastic surface-mounted package; 3 leads	SOT23

4. Marking

Table 4. Marking

Type number	Marking code	Description
BFR94A	NL*	* = p : made in Hong Kong
		* = w : made in China

5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

	Parameter	Conditions	Min	Max	Unit
V_{CBO}	collector-base voltage	open emitter	-	20	٧
V_{CEO}	collector-emitter voltage	open base	-	15	٧
V_{EBO}	emitter-base voltage	open collector	-	2	٧
Ic	collector current		-	25	mA
P _{tot}	total power dissipation	$T_{sp} \le 95 ^{\circ}C$; see Figure 2	-	300	mW
T _{stg}	storage temperature		-65	+150	°C
T _j	junction temperature		-	+150	°C

^[1] T_{sp} is the temperature at the solder point of the collector pin.

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6. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Тур	Unit
$R_{th(j-sp)}$	thermal resistance from junction to solder point	$T_{sp} \le 95 ^{\circ}C$	260	K/W

^[1] T_{sp} is the temperature at the solder point of the collector pin.

7. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _{CBO}	collector-base cut-off current	I _E = 0 A; V _{CB} = 10 V	-	-	50	nA
h _{FE}	DC current gain	$I_C = 15 \text{ mA}$; $V_{CE} = 10 \text{ V}$; see Figure 3	65	90	135	
C _c	collector capacitance	$I_E = I_e = 0 \text{ A}$; $V_{CB} = 10 \text{ V}$; $f = 1 \text{ MHz}$: see Figure 4	-	0.6	-	pF
C _e	emitter capacitance	$I_C = I_C = 0 \text{ A}; V_{EB} = 10 \text{ V}; f = 1 \text{ MHz}$	-	1.2	-	pF
C _{re}	feedback capacitance	$I_C = i_c = 0 \text{ mA}; V_{CE} = 10 \text{ V}; f = 1 \text{ MHz}$	-	0.35	-	pF
f _T	transition frequency	$I_C = 15 \text{ mA}; V_{CE} = 10 \text{ V}; f = 500 \text{ MHz};$ see Figure 5	-	5	-	GHz
G _{UM}	unilateral power gain	$I_C = 15 \text{ mA}; V_{CE} = 10 \text{ V}; T_{amb} = 25 \text{ °C}$ [1]				
		f = 1 GHz	-	14	-	dB
		f = 2 GHz	-	8	-	dB
NF	noise figure	$I_C = 5$ mA; $V_{CE} = 10$ V; $\Gamma_S = \Gamma_{opt}$; $T_{amb} = 25$ °C; see Figure 12 and Figure 13				
		f = 1 GHz	-	2.1	-	dB
		f = 2 GHz	-	3	-	dB
Vo	output voltage	[2][3]	-	150	-	mV
IMD2	second-order intermodulation distortion	see <u>Figure 15</u> [2][4]	-	-50	-	dB

[1] G_{UM} is the maximum unilateral power gain, assuming S_{12} is zero and

$$G_{UM} = 10 \log \frac{\left|S_{2l}\right|^2}{(1 - \left|S_{Il}\right|^2)(1 - \left|S_{22}\right|^2)} \ dB.$$

- [2] Measured on the same crystal in a SOT37 package (BFR90A).
- [3] IMD = -60 dB (DIN 45004B); I_C = 14 mA; V_{CE} = 10 V; R_L = 75 Ω ; VSWR < 2; T_{amb} = 25 °C;

$$V_p = V_O \mbox{ at IMD} = -60 \mbox{ dB}; f_p = 795.25 \mbox{ MHz};$$

$$V_q = V_O - 6 \text{ dB at } f_q = 803.25 \text{ MHz};$$

$$V_r = V_O - 6 \text{ dB}$$
 at $f_r = 805.25 \text{ MHz}$;

measured at $f_p + f_q - f_r = 793.25 \text{ MHz}$

[4] I_C = 14 mA; V_{CE} = 10 V; R_L = 75 Ω ; VSWR < 2; T_{amb} = 25 °C;

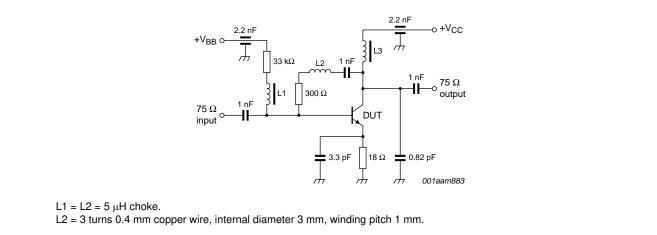
$$V_p = 60 \text{ mV at } f_p = 250 \text{ MHz};$$

$$V_q = 60 \text{ mV} \text{ at } f_p = 560 \text{ MHz};$$

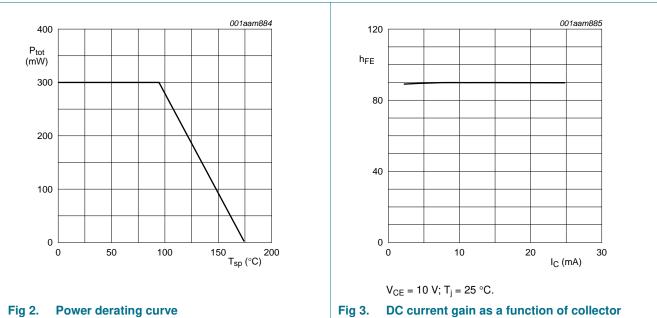
measured at $f_p + f_q = 810 \text{ MHz}$

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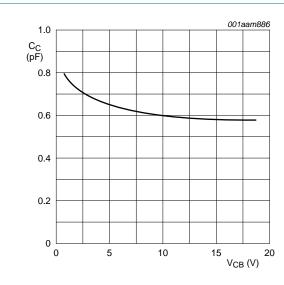


Intermodulation distortion and second harmonic distortion MATV test circuit Fig 1.



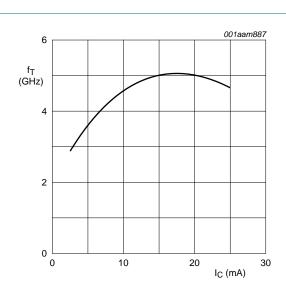
current; typical values

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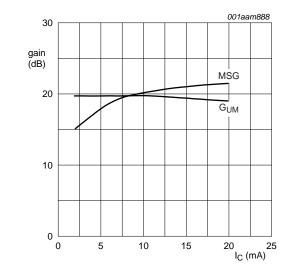
 $I_C = i_C = 0$ mA; f = 1 MHz; $T_j = 25$ °C.

Fig 4. Collector capacitance as a function of collector-base voltage; typical values



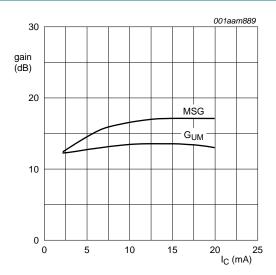
 V_{CE} = 10 V; f = 500 MHz; T_{amb} = 25 °C.

Fig 5. Transition frequency as a function of collector current; typical values



V_{CE} = 10 V; f = 500 MHz. MSG = maximum stable gain.

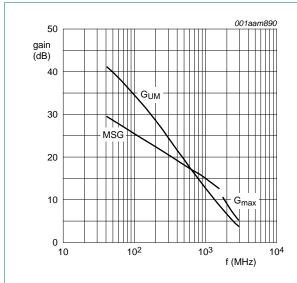
Fig 6. Gain as a function of collector current; typical values



 $V_{CE} = 10 \text{ V; f} = 500 \text{ MHz.}$ MSG = maximum stable gain.

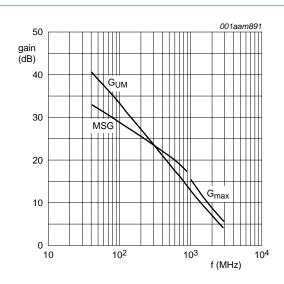
Fig 7. Gain as a function of collector current; typical values

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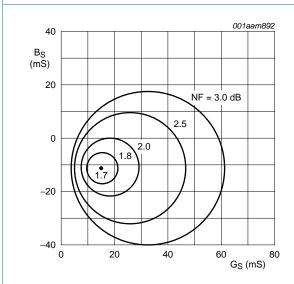
$$\begin{split} &I_C=5 \text{ mA; V}_{CE}=10 \text{ V.} \\ &MSG=\text{maximum stable gain.} \\ &G_{max}=\text{maximum available gain.} \end{split}$$

Fig 8. Gain as a function of frequency; typical values



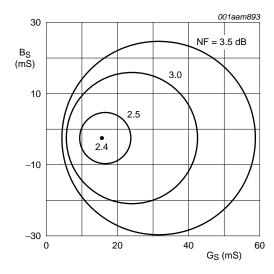
$$\begin{split} I_C &= 5 \text{ mA; } V_{CE} = 10 \text{ V.} \\ MSG &= \text{maximum stable gain.} \\ G_{max} &= \text{maximum available gain.} \end{split}$$

Fig 9. Minimum noise figure as a function of frequency; typical values



 $I_C = 4 \text{ mA}$; $V_{CE} = 10 \text{ V}$; f = 800 MHz.

Fig 10. Circles of constant noise figure; typical values



 $I_C = 14 \text{ mA}$; $V_{CE} = 10 \text{ V}$; f = 800 MHz.

Fig 11. Circles of constant noise figure; typical values

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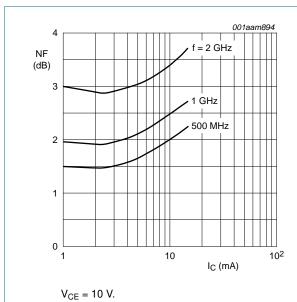


Fig 12. Minimum noise figure as a function of collector current; typical values

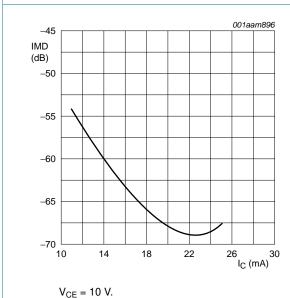


Fig 14. Intermodulation distortion as a function of collector current; typical values

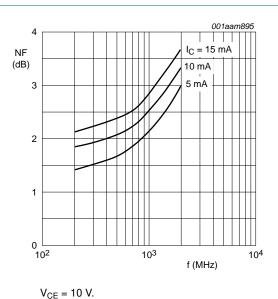


Fig 13. Minimum noise figure as a function of frequency; typical values

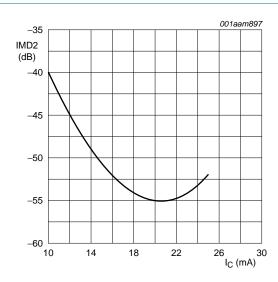
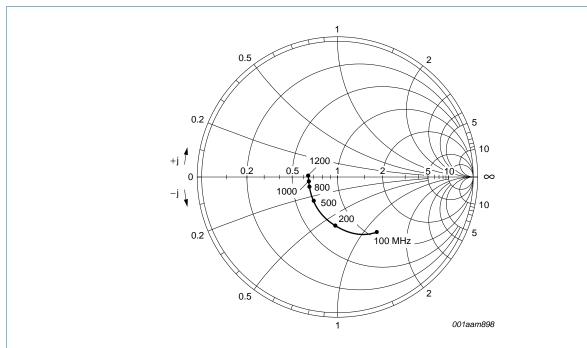


Fig 15. Second-order intermodulation distortion as a function of collector current; typical values

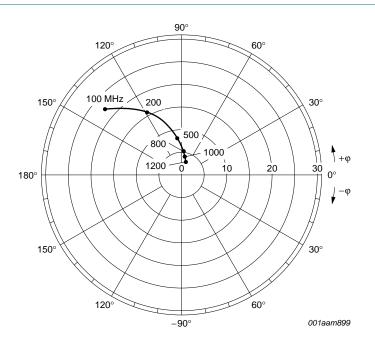
 $V_{CE} = 10 \text{ V}.$

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 V_{CE} = 10 V; I_{C} = 14 mA; Z_{O} = 50 $\Omega;$ T_{amb} = 25 $^{\circ}C.$

Fig 16. Common emitter input reflection coefficient (S₁₁); typical values



 V_{CE} = 10 V; I_{C} = 14 mA; T_{amb} = 25 °C.

Fig 17. Common emitter forward transmission coefficient (S₂₁); typical values

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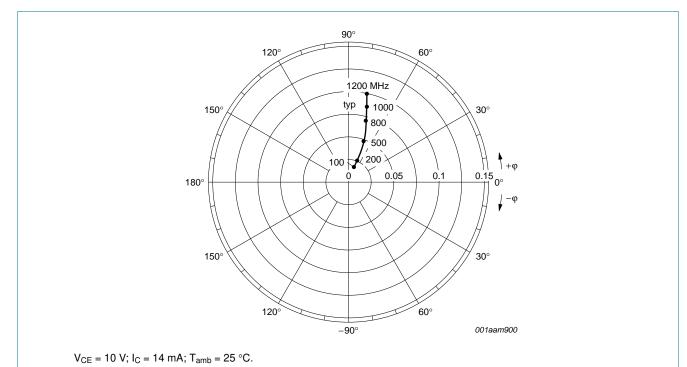
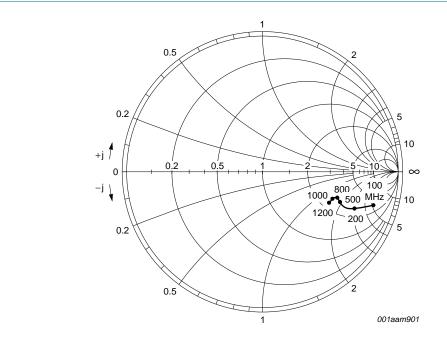


Fig 18. Common emitter reverse transmission coefficient (S₁₂); typical values



 $\mbox{V}_{\mbox{CE}}$ = 10 V; $\mbox{I}_{\mbox{C}}$ = 14 mA; $\mbox{Z}_{\mbox{O}}$ = 50 $\Omega;$ $\mbox{T}_{\mbox{amb}}$ = 25 °C.

Fig 19. Common emitter output reflection coefficient (S₂₂); typical values

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8. Package outline

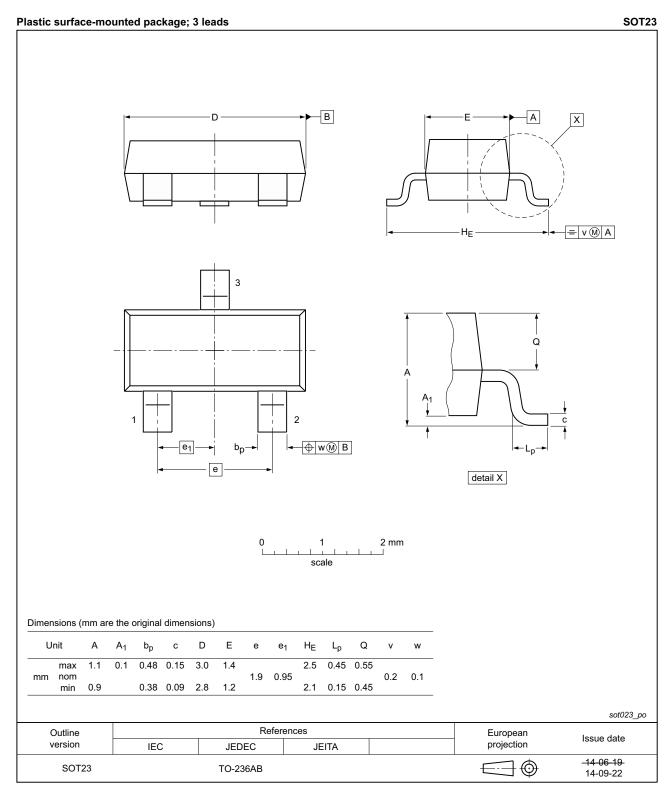


Fig 20. Package outline SOT23

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9. Abbreviations

Table 8. Abbreviations

Acronym	Description
NPN	Negative Positive Negative
PNP	Positive Negative Positive
RF	Radio Frequency
MATV	Master Antenna Television
VSWR	Voltage Standing Wave Ratio

10. Revision history

Table 9. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BFR94A v.4	20141002	Product data sheet	-	BFR94A v.3
Modifications:	Table 2 on page	ge 2: changed graphic symbol		
	Figure 20 on p	page 10: updated		
BFR94A v.3	20101115	Product data sheet	-	BFR94A v.2
BFR94A v.2	19971204	Product data sheet	-	-

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Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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